Optical near-field imaging and nanostructuring by means of laser ablation

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In this review we consider the development of optical near-field imaging and nanostructuring by means of laser ablation since its early stages around the turn of the century. The interaction of short, intense laser pulses with nanoparticles on a surface leads to laterally tightly confined, strongly enhanced electromagnetic fields below and around the nano-objects, which can easily give rise to nanoablation. This effect can be exploited for structuring substrate surfaces on a length scale well below the diffraction limit, one to two orders smaller than the incident laser wavelength. We report on structure formation by the optical near field of both dielectric and metallic nano-objects, the latter allowing even stronger and more localized enhancement of the electromagnetic field due to the excitation of plasmon modes. Structuring with this method enables one to nanopattern large areas in a one-step parallel process with just one laser pulse irradiation, and in the course of time various improvements have been added to this technique, so that also more complex and even arbitrary structures can be produced by means of nanoablation. The near-field patterns generated on the surface can be read out with high resolution techniques like scanning electron microscopy and atomic force microscopy and provide thus a valuable tool—in conjunction with numerical calculations like finite difference time domain (FDTD) simulations—for a deeper understanding of the optical and plasmonic properties of nanostructures and their applications.

Keywords: nanostructuring; optical near field; laser ablation; plasmonics


Introduction and background

Small particles at surfaces have become an important research topic ever since nanotechnology has developed to one of the modern key technologies. Often these particles are unwanted contaminants, e.g. in micro- and nanoelectronics. On the other hand, nano-sized particles can also be used for the generation of surface structures, as will be shown in this review. We give here, from a very personal perspective, a brief survey of the history of nanostructuring surfaces by means of the optical near fields of such small particles which are illuminated by short laser pulses. In this section we start with the background of this topic, where a crucial role was played by the technique of laser cleaning, out of which the near-field nanostructuring developed. In sections Optical near fields of dielectric nanostructures and Optical near fields of plasmonic nanostructures we will then discuss the formation of nanostructures by laser ablation in the optical near fields of dielectric and plasmonic nanoparticles, respectively.

The investigation of small particles on a substrate, interacting with intense light fields, started around 1990. At that time surface contamination by particulates was one of the most serious problems faced by the microelectronic industry, because a major part of the yield losses in Integrated Circuits (ICs) was attributed to it.
Although at that time the characteristic length scale of IC technology was relatively large compared to today’s standards (> 500 nm), the available cleaning techniques based on wiping and brushing, ultrasonics and liquid chemicals were not efficient enough to reliably remove particles with a size as small as 100 nm, which could be detrimental for the production of ICs at that time. Therefore, new gentle and also environmentally friendly cleaning techniques were sought for.

A promising technique in this direction, published in 1991 by the group of A.C. Tam, was the so-called laser cleaning. The basic idea of this concept was to heat the substrate which was to be cleaned by a nanosecond laser pulse. The rapid thermal expansion of the substrate will then accelerate particles on the surface, and when the expansion comes to a halt at the end of the heating process, the particles detach from the surface due to inertia forces strong enough to overcome the forces of particle adhesion. Already in these early investigations, this effect of particle removal was sometimes enhanced by a thin liquid film, e.g. a water-alcohol mixture, condensed onto the substrate immediately before the laser pulse. As the substrate is momentarily heated, the temperature of the film also rises, until bubble nucleation at the solid-liquid interface takes place, and the subsequent explosive evaporation of the liquid enforces the removal of the contaminants. This latter mechanism was later termed “Steam Laser Cleaning” (SLC), while the first one was called “Dry Laser Cleaning” (DLC). An example for the cleaning action by this method is shown in Fig. 1. Altogether, high cleaning efficiencies close to 100 percent were reached at high enough laser intensities. (It should be mentioned that parallel to this SLC concept, which relied on the indirect heating of the liquid film via the substrate, an alternative scheme was developed in the group of S. Allen. There the liquid film was heated directly using a CO₂ laser with a wavelength that is strongly absorbed by the liquid. Also in this case, good cleaning results due to the explosive evaporation of the film were reported.)

In the years following these first developments, the processes occurring during both DLC and SLC were investigated in more detail. One aspect was the mechanism of bubble nucleation at the liquid-solid interface, which was studied in a sequence of papers by Yavas et al. Also, the thermal expansion of the substrate and the concomitant acceleration of the surface was measured with nanosecond time resolution. The resulting accelerations were found to be in the range of 10⁷ m/s², i.e. 6 orders of magnitude higher than the acceleration due to gravity, but still somewhat too small to overcome the expected adhesion forces. One of the reasons for this discrepancy will be discussed at the end of this section.

In 1995, a joint European project was initiated, dedicated to various forms of laser cleaning, in which groups from Austria, France, Germany, Greece and Spain collaborated. The aims of this project were relatively broad, reaching from cleaning industrial oxidized surfaces to the restoration of art work, but one central topic was laser cleaning of delicate surfaces like silicon wafers from nanoparticles. Systematic comparisons between DLC and SLC were carried out, in which lasers with different wavelengths from UV to near IR and with pulse durations ranging from the nanosecond down to the femtosecond regime were tried out. A major step towards a quantitative understanding was also replacing the so far mostly used test contaminants, irregularly

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**Fig. 1 |** Scanning electron microscope (SEM) photos showing SLC of 0.1-μm alumina particles from a Si surface (with water film assistance). The KrF laser (pulse duration 16 ns, wavelength λ = 248 nm) had a fluence of 120 mJ/cm², and 20 pulses were used. Figure reproduced with permission from ref. 3, American Institute of Physics.
shaped powders of alumina or silica, by well-defined spherical particles with a monodisperse size distribution\textsuperscript{12,13}. Such particles are available with various diameters as colloidal suspensions which can be spin-coated on the test surface.

An example of Polystyrene (PS) spheres with a diameter of 480 nm is presented in Fig. 2. In the DLC experiments, these samples were irradiated with the cleaning laser pulse in ambient atmosphere; for the SLC measurements an additional burst of water-alcohol vapor, supplied through a nozzle, was condensed onto the Si substrate before the illumination. The cleaning efficiency was either evaluated by simply counting the number of particles in the irradiated area before and after the laser pulse, or by measuring the light scattering from the remaining particles\textsuperscript{14}.

![480 nm PS](image)

**Fig. 2** | SEM image (50 × 50 μm\textsuperscript{2}) of 480 nm PS particles spin coated on a silicon wafer. The insert shows a blow-up demonstrating the spherical shape of these colloidal particles. Figure reproduced with permission from ref.\textsuperscript{12}, Spring Nature.

Representative results for the cleaning efficiency are shown in Fig. 3 for the case of SLC. The data reveal a threshold fluence for the onset of cleaning (110 mJ/cm\textsuperscript{2}), and nearly complete cleaning is achieved around a fluence of 200 mJ/cm\textsuperscript{2}, which is well below the onset of melting of the (bare) Si surface for 8 ns pulses at the used wavelength of 532 nm. The efficiency turned out to be essentially independent of particle size and material, as it is expected that the explosive evaporation of the liquid layer is the dominating detachment mechanism.

This is different for the case of DLC, as plotted in Fig. 4, where SLC and DLC data are compared. First of all, the cleaning threshold for DLC is distinctly higher than that for SLC, and the efficiency reaches just 50% at a laser fluence where the Si surface starts to melt. What is more, the DLC data depended crucially on the humidity in the air of the laboratory. This was already mentioned in the early work of laser cleaning\textsuperscript{3}, but it became particularly clear in the course of a collaboration between the Data Storage Institute in Singapore and the Konstanz lab in Germany. On a dry winter day in Konstanz the DLC efficiency was observed to be considerably lower than for the identical sample in Singapore. This could be ascribed to the significantly higher humidity in the Singapore lab, which led to more pronounced capillary condensation of a liquid water meniscus around the area where the particle touches the surface. Upon irradiation with the laser pulse, this gives rise to explosive evaporation, thus the term “Dry Laser Cleaning” is not really justified in ambient air, because of the partial contribution of the SLC mechanism. This was corroborated by similar cleaning experiments under high vacuum conditions, in which a further efficiency reduction compared to DLC in ambient atmosphere was observed. Results qualitatively similar to the nanosecond laser cleaning experiments discussed so far were found for picosecond laser pulses, the absolute cleaning threshold values being somewhat reduced for the ps compared to the ns pulses\textsuperscript{12,15}.

The state of the interpretation of DLC at the end of the 1990s thus was that the detachment of particles is due to the combined action of acceleration (or rather deceleration) of the substrate surface and the explosive evaporation of adsorbed water, the contributions of these two...
processes depending on the details of the experiment. In several theoretical investigations, the effect of the thermal expansion was modelled; some of these studies came to the conclusion that the mechanical model could describe the experimental results reasonably well, whereas others found that the predicted mechanical forces were too small to account for the experimental cleaning thresholds\textsuperscript{16–20}.

**Optical near fields of dielectric nanostructures**

In the following we will mainly consider commercial silicon wafers as the substrate, on the one hand because these wafers were one of the main objects of laser cleaning\textsuperscript{11}, but also because they are very smooth, and therefore any influence of the particles on the ablation process is more readily visible than for, e.g., evaporated metal films.

We present here the state of the art at the beginning of the year 2000, when these phenomena were discussed at a conference “High Power Laser Ablation III”, held in April 2000 in Santa Fe, USA.

**Laser-induced surface damage**

Most of the experiments up to that point had been carried out with laser pulses in the ns range. In order to evaluate the potential of DLC and SLC for the cleaning of commercial silicon wafers, the studies from then on systematically included also shorter laser pulses, because - as mentioned above - the intensity window between cleaning threshold and melting of the silicon was somewhat broader for ps lasers, an important aspect for potential applications.

In the experiments with ps pulses (and somewhat later also with fs pulses) it turned out that the picture of DLC outlined above was not complete: when surfaces cleaned in this way were carefully inspected by SEM or AFM, surface defects in the form of small holes became visible, as shown in Fig. 5 for 800 nm PS spheres on a Si substrate, irradiated with a 30 ps pulse\textsuperscript{15}. A similar observation of surface damages, but irregular in shape, was observed at about the same time in DLC studies of glass with nanosecond UV laser pulses, where Al\textsubscript{2}O\textsubscript{3} powder was used as test contaminant\textsuperscript{21,22}.

![Fig. 5 | Scanning electron micrograph of a cleaned area (DLC, \lambda = 583 nm, FWHM 30 ps) in a sample contaminated with 800 nm PS spheres. Elliptical holes can be found over the illuminated region, and also a remaining particle can be seen. Figure reproduced with permission from ref.\textsuperscript{15}, SPIE.](image-url)

It was suggestive that the origin of these surface damages were the optical near fields of the test particles. This interpretation was supported by Mie calculations\textsuperscript{23}, which showed that the intensity underneath the particles can be enhanced by an order of magnitude or even more (depending on the particle size, Fig. 6), and is thus locally well above the ablation threshold for the Si substrate.

![Fig. 6 | Mie calculation of the optical near field of a spherical transparent particle with a diameter \(d \gg \) laser wavelength \(\lambda\). The scale on the color code gives the enhancement factor.](image-url)
when the incident laser fluence is above the cleaning threshold. The nanoholes in the surface are therefore nanoscopic ablation craters generated by the optical near field. At about the same time, Lu et al. and Zheng et al. considered the optical near field of a small transparent sphere in their investigations of laser-induced particle removal from silicon wafers. In these papers only the enhancement of the thermal expansion of the substrate, and no laser ablation, was discussed.

At that point it was not clear yet whether these holes are just a by-product of the irradiation process, or whether this local ablation with its additional pressure acting upon the particle is crucial for the particle removal. In an additional experiment, the initial positions of the spheres on the wafer were therefore marked by evaporating a thin (10 nm) SiO₂ layer after the deposition of the particles, but before the laser cleaning. After the removal of the particles, their original position could thus be determined by a contrast in the SEM pictures, as seen in Fig. 7.

![Fig. 7 | Holes generated during DLC of a silicon surface with a fs laser pulse (150 fs, λ = 800 nm) by an aggregate of six 1700 nm PS spheres. Figure reproduced with permission from ref. 15, SPIE.](image)

The circular disk-like, slightly brighter regions in Fig. 7, which are due to the thinner (natural) oxide film on the silicon, mark the “footprint” of the spherical particles. It was found that every such footprint had an ablation hole in its center, and that in the fs and ps DLC experiments the removal of particles was always accompanied by the appearance of such holes. Vice versa, no holes were found under particles that had not been removed by the laser pulse. Hence the ablation process could in these cases be directly related to the ejection of material from the silicon substrate, which then also leads to the observed crater formation.

This was further corroborated by a comparison of vertical and inclined irradiation of the test particles. Figure 8(a) shows an example where a 1.7 μm sphere was irradiated at an angle of incidence of 45° from the left. The ablation hole is therefore not in the center, but at the right edge of the particle’s footprint. Another example is given in Fig. 8(b), where an aggregate of 3 particles, also irradiated at 45°, detached only partly. Two of the spheres generated ablation holes, and the traces of the substrate material deposited on the spheres due to the ablation are clearly visible.

![Fig. 8 | Holes generated during DLC of a silicon surface with a fs laser pulse (150 fs, λ = 800 nm). (a) laser beam incident at an angle of 45° from the left side. (b) 45° incidence from the back. Figure reproduced with permission from ref. 27, John Wiley and Sons. A more detailed description of ablation effects upon inclined irradiation of nanospheres has been presented by Wang et al. 131.](image)

### Influence of particle size

Similar holes were also found for smaller particles, but with somewhat different shape. The essential parameter is the ratio between the particle diameter \( d \) and the laser wavelength \( \lambda \). For \( d/\lambda > 1 \), as in the examples shown so far, the particle acts essentially like a spherical microlens. For smaller sphere diameters, the character of the optical near field gradually changes towards the field of a dielectric dipole. This is shown in Fig. 9. At the same time, the smaller the ratio \( d/\lambda \) is, the more the field enhancement is reduced. As a result, the incident intensity necessary for particle detachment is expected to increase. Experimentally, this was confirmed: while for 1700 nm spheres the cleaning threshold was 11 mJ/cm², an incident flux of 25 and 80 mJ/cm² was necessary to remove 800 nm and 320 nm particles, respectively, using femto-
second laser pulses with $\lambda = 800$ nm and FWHM = 150 fs

Experimentally, the asymmetry due to the dipole character of the optical near field for the smaller particles could already be guessed from the slightly elliptical hole structures in Fig. 5. An example where the dipolar character is more obvious, for a $d/\lambda$ value of 0.4, is depicted in Fig. 10. The dumbbell-like shape of the hole in Fig. 10(b), determined by AFM, clearly reflects the intensity distribution near the field in Fig. 10(a). In addition, the hole is surrounded by a circular elevated rim. It was shown that the rim consists of SiO$_x$, it is thus material which is ablated, backscattered from the particle during the detachment, and is partly oxidized during this process. The similarity between the simulated and the experimental pattern in Fig. 10 suggested that local ablation of the smooth silicon substrate can be used to image the optical near field distribution of nanoscopic objects. This will be further discussed in Section Optical near fields of plasmonic nanostructures.

**Temporal development of near-field induced structure formation**

All the images of near-field induced structures shown so far represent the final result of the ablation process. In order to understand the structuring in detail, however, it is also desirable to investigate this process with high time resolution. For accessing the relevant time scale, femtosecond microscopy is necessary. Figure 11 shows a sequence of frames, obtained by a pump-probe technique, which illustrates the near-field induced formation of a hole generated in a Si substrate by irradiating a 7.9 μm diameter silica sphere with a fs laser pulse. Already for a delay of 200 fs, one can observe the formation of a bright spot, located adjacent to the particle position, which is interpreted as evidence for the formation of a dense electron-hole plasma. At 4 ps delay, this formerly bright region turns dark, indicating that strong ablation is already
taking place, and after some 10 ps the image hardly changes. The authors conclude from their study, by comparison with “usual” far-field ablation, that in the tightly focused near-field region the onset of strong ablation is shifted to shorter times.

When laser pulses longer than a few picoseconds are used for structuring, the character of the structure formation changes, because on the ns time scale lateral heat flow in the substrate cannot be neglected any more. The thermal diffusion length \( l = 2(D\tau)^{1/2} \) (\( D \) is the thermal diffusion coefficient and \( \tau \) is the laser beam dwell time) reaches the structure size. For a silicon substrate, e.g., one finds an estimated value \( l \approx 1 \mu m \) for \( \tau = 8 \) ns. Moreover, melting and lateral flow of the molten substrate become important. It is therefore to be expected that the near-field focusing of ns pulses leads to structures which are smeared out, compared to the fs counterpart. This is indeed the case, as illustrated in Fig. 12.

Particle-enhanced laser writing and nanostructuring of regular hole arrays

Once it was clear that the observed nano-holes on the laser-cleaned Si surfaces were caused by the optical near fields of the test particles, it was a relatively small step toward using this effect also for intentional nanopatterning of surfaces.\(^{26-27}\) If one is not interested in a random configuration of holes, as it would be generated by the spatial distribution of spheres in Fig. 2, but would rather produce a regular array of holes, colloid spheres can be relatively easily applied also for that purpose, since they can aggregate (due to their monodispersity) to self-organized, densely packed monolayers with hexagonal symmetry.

The tendency of these spheres to form regular, densely-packed aggregates in the drying process is already visible in Fig. 7, where the holes were generated by a cluster of six particles. Under appropriate conditions, one can prepare ordered arrays on a scale of cm\(^2\), which then can be used to generate millions of nanoholes with one laser pulse irradiation. A detailed fraction of such a patterned surface, Si in this case, is shown in Fig. 13(a), where in the upper part the colloid spheres are still present. The diameter, depth and distance of the holes can be varied over a broad range by choosing the right colloid sphere size and the laser intensity.

This technique has been used by a number of groups.\(^{28-45}\) Figure 13(b) shows a pattern, again on a Si substrate, with holes as small as 57 nm FWHM, and even smaller holes down to 30 nm in diameter have been
reported. Various surfaces have been structured in that way, among them polymers\textsuperscript{22,23,35}, glass\textsuperscript{30,41}, and also thin metal films\textsuperscript{26,43} and silicon membranes\textsuperscript{46}. Often femtosecond lasers have been used for the structuring process, as in Fig. 13, where the holes are then the result of a nano-ablation process. However, longer pulse lengths are also possible to use for structuring, as seen in the structured thin-film samples shown in Fig. 14, which were produced with a KrF laser with a pulse length of 23 ns. In this case, the authors ascribe the holes to local melting and evaporation. Beyond the holes, also elevated structures, referred to as nanobumps and nanocones, can result from the irradiation with ns laser pulses due to transport processes in the substrate at such relatively long time scales\textsuperscript{38,44,47–49}.

More complex periodic patterns can be generated by immersing the substrate together with the particle mask into liquids with various refractive indices\textsuperscript{50,51}. The detailed structure of the patterns which are then formed upon laser irradiation depends on the difference of the refractive indices of the particles and the surrounding liquid medium.

A further development was reported by Guo et al.\textsuperscript{52}, who investigated near-field parallel nanofabrication of arbitrary-shaped periodic patterns by using variable angles of incidence of the laser beam onto the nanosphere monolayer. The principle and a resulting pattern generated by a KrF laser (15 ns, 248 nm) in a 20 nm thick eutectic Sb\textsubscript{70}Tb\textsubscript{30} film coated on a polycarbonate substrate are shown in Fig. 15.

![Fig. 13](image1)

**Fig. 13** | (a) Nanohole pattern generated by illuminating an ordered array of PS microspheres with a single laser pulse ($r = 150$ fs, $\lambda = 800$ nm). Some remaining spheres are also seen. (Sphere diameter 800 nm; similar images are shown in ref.\textsuperscript{35}). (b) Silicon nanoholes fabricated on a (100) Si surface by using a single-shot 265.7-nm Ti:sapphire laser radiation (300 fs, fluence 15 ± 3.5 mJ/cm$^2$) together with a regular lattice of SiO$_2$ microspheres ($r = 150$ nm). The width of the holes at FWHM is 57 ± 0.5 nm and their depth with respect to the original silicon surface $6 ± 1$ nm. Figure reproduced with permission from ref.\textsuperscript{41}, Springer Nature.

![Fig. 14](image2)

**Fig. 14** | (a) (i) and (ii) SEM image of a periodic pit array in a 35 nm thick Al film on silicon, formed after the illumination of 0.95 μm SiO$_2$ particles by a single pulse with a fluence of 300 mJ/cm$^2$ (KrF excimer laser, $\lambda = 248$ nm, pulse width 23 ns). (b) AFM image and depth profile of a pit. Figure reproduced with permission from ref.\textsuperscript{34}, AIP Publishing.

Arbitrary patterning by means of a direct-write optical method using the near field of microspheres in optical traps has been described by the group of Arnold et al.\textsuperscript{33–35}. An individual microsphere or also a microsphere array, held by optical tweezers, are used as near-field objectives in aqueous solution above a substrate which can be positioned by a translation stage. An AFM image of a hole created this way in a polycarbonate surface is shown in Fig. 16.

In Table 1, the experiments on optical near-field nanostructuring with dielectric micro- and nanospheres are summarized. The created nanostructures are named as in the corresponding publications, either “craters”, “holes” or “dents” (if a depression is generated) or “bumps”, “hillocks” or “cones” (for elevations). Most structures are 100 nm in size or larger; only structures below 100 nm...
are mentioned in the column “special features”. Only the most important parameters are listed here, for details the reader is referred to the original papers.

A few years after the first experiments on laser-induced ablation in the optical near field of micro- and nanospheres, the term “photonic nanojet” was coined for the tightly focused light distribution near the shadow-side surface of the microlenses. Many investigations have since then been carried out, where the effect of the strongly localized, high intensity light field of these nanojets has been used for applications in various fields in optics, electronics, and even biomedical research, well beyond laser ablation nanostructuring. Nonlinear optical phenomena have been exploited, e.g., in the optical absorption of VO₂ and graphene oxide. Reviews about photonic nanojets can be found, for example, in ref.  and .

The investigations described above and the results obtained for the nanostructuring of surfaces by means of the optical near field of small transparent spheres have also stimulated a development in the “reverse” direction, from near field to far field, namely an important improvement of optical microscopy: using silica microspheres with diameters between 2 and 9 μm, integrated in a classical optical microscope, the group of M. Hong has obtained a considerable extension of the optical resolution, and has imaged feature sizes as small as 23 nm. Chen et al. have presented a recent review about this technique, including its potential and perspective. A general overview over the near-field properties of high refractive index dielectric nanostructures and their use in functional nanostructures at optical frequencies has been given by Decker and Staude.

**Optical near fields of plasmonic nanostructures**

While dielectric particles are already quite efficient for obtaining optical near fields on a scale distinctly smaller than the wavelength of light, an even stronger localization can be achieved with metallic nanostructures due to their plasmonic excitations. In scanning probe microscopy, this was used as a further advancement of the Scanning Near-Field Optical Microscope (SNOM): instead of a tiny aperture at the end of a glass fiber, one can also illuminate a fine metallic tip, with which – as an antenna – light can be coupled from the near field into the far field (and vice versa). This so-called apertureless SNOM (aSNOM) has been developed towards a powerful microscopy technique with excellent resolution.

One of the first efforts to exploit this antenna or “lightning rod” effect towards nanostructuring of surfaces was made already in 1996 by Jersch and Dickmann. These authors illuminated the metallic tip of an STM with the pulses of a Nd:YAG laser (pulse width ~ 10 ns) and could generate in this way hole- or hillock-like structures in the range of several nm. They called their technique FOLANT (Focusing of Laser Radiation in the Near Field of a Tip). Shortly afterwards it was demonstrated, however, these structures were not caused by the high electromagnetic field at the tip apex, as originally suggested, but resulted rather from the thermal expansion of the illuminated tip, which leads to a momentary mechanical contact with the substrate. The appearance of the nanostructures was thus dominated by the adhesion properties of the tip/sample combination. Only a few years later, evidence was presented by the Singapore group that under certain conditions the near-field enhancement of ns pulses dominates over the mechanical modification of the substrate following from the thermal expansion of the tip apex. Subsequently, Grigopoulos and coworkers, demonstrated optical-near-field-induced structuring by an STP tip illuminated by fs laser pulses, where thermal effects play an inferior role compared to ns pulses.

**Triangular plasmonic nanostructures**

In order to disentangle structuring effects due to optical near fields from those originating from a pulsed mechanical contact between tip and sample, one can use proper
Table 1 | Experiments on nanostructuring of various surfaces by means of local laser ablation or melting, using the optical near field of dielectric spheres.

<table>
<thead>
<tr>
<th>Year</th>
<th>Structured material</th>
<th>Nanosphere size (nm) and material</th>
<th>λ (nm)</th>
<th>Laser pulse length</th>
<th>Created nanostructures</th>
<th>Special feature</th>
<th>Reference</th>
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<td>320–1700 PS</td>
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<td>30 ps</td>
<td>holes</td>
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<td>500 SiO₂</td>
<td>248</td>
<td>23 ns</td>
<td>hillocks</td>
<td>ref. 26</td>
<td></td>
</tr>
<tr>
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<td>Si, BK7 glass</td>
<td>320–1700 PS</td>
<td>248</td>
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<td>holes</td>
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<tr>
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<td>320–1700 SiO₂, PS</td>
<td>248</td>
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<td>holes</td>
<td>ref. 28</td>
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<td>100–2000 PS</td>
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<td>28 ns</td>
<td>holes</td>
<td>ref. 30</td>
<td></td>
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<td>3000 SiO₂</td>
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<td>28 ns</td>
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<td>ref. 47</td>
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<td>ref. 49</td>
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<td>ref. 51</td>
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<td>ref. 52</td>
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<td>arb. patterns</td>
<td>ref. 53</td>
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<td>Si</td>
<td>350–5000 SiO₂, PS</td>
<td>248</td>
<td>23 ns</td>
<td>arb. patterns</td>
<td>ref. 54</td>
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</table>
nanoparticles deposited on the surface, instead of a scanning probe tip. Effects of thermal expansion are then considerably smaller. For the generation of locally tightly confined fields and large enhancement factors, metallic nanostructures with tips as sharp as possible are preferable. Such structures can be produced with the help of the self-organized compact monolayers of colloid spheres mentioned already above. Using these particle arrays as evaporation masks, flat triangular nanostructures can be prepared in a quite versatile way, where both the size and the thickness can be chosen over a wide range from several ten nanometers up to microns by using the proper colloid sphere size and evaporation conditions\textsuperscript{28−31}. Also, the material of the evaporated nanostructures can be chosen at will. For most of the investigations to be discussed below the metal of choice was gold because of its superior plasmonic properties and resistance against corrosion. The main advantage of this “colloid lithography” is that, while relatively easy to be implemented, it allows one to produce periodic arrays of uniform nanostructures over areas as large as the colloid mask (cm\textsuperscript{2}) in a parallel fashion. Moreover, the triangles prepared in this way can have tip radii as small as 5 nm\textsuperscript{83}, a scale which is difficult to achieve by conventional lithographic techniques. An example of such an array of nano-triangles is shown in Fig. 19. In addition to these colloid-generated triangles, many other plasmonic structures have been used for optical near-field studies, like spheres\textsuperscript{44−46} and various kinds of rod-, bow-tie-, disc-like etc. nanoantennas, mostly prepared by electron- and ion-beam lithography. Some of them will be discussed further below.

The first time that plasmonic structures like the ones shown in Fig. 17 were used for nanoablation experiments was – to the best of our knowledge – reported in 2004\textsuperscript{83}. As for the dielectric spheres in the last section, silicon was the substrate, and single femtosecond laser pulses served as light source. The intensity of the pulse was adjusted to a value sufficiently low so that the parts of the substrate far away from the triangles were not affected. Figure 18 shows the result of such an experiment. The original gold structures seen in Fig. 18(a) were completely removed by the laser pulse (possible mechanisms are discussed by Huang et al.\textsuperscript{87}), and the silicon substrate

\begin{figure}[h]
\centering
\includegraphics[width=0.5\textwidth]{fig17.png}
\caption{(a) SEM image of a regular array of triangular nanostructures prepared by colloid lithography. The colloid monolayer used as an evaporation mask has only been partly removed in this case. (b) AFM image of one triangle. Note that the scale in vertical direction is enlarged compared to the scale in plane. Figure reproduced with permission from ref.\textsuperscript{106}, under the a Creative Commons Attribution License 2.0.}
\end{figure}

\begin{figure}[h]
\centering
\includegraphics[width=0.5\textwidth]{fig18.png}
\caption{Gold triangles on silicon, side length 450 nm, 25 nm thick. (a) As prepared. (b) After irradiation with one laser pulse (laser source: Ti:sapphire laser, λ = 800 nm, pulse width 150 fs). (c) After chemical removal of the gold. Light polarization vertical (indicated by the arrow on the right side). In (b), the former positions of the gold triangles are outlined as contours, formed by gold clusters which developed in the evaporation process through the colloid mask. Figure reproduced with permission from ref.\textsuperscript{83}, AIP Publishing.}
\end{figure}
was intact mostly outside and also inside the triangle areas, except for some of the triangle corners, where ablation holes, discernible by the dark spots, are clearly visible. These holes are surrounded by elevated rims, as in parts of the ablation holes in Section Optical near fields of dielectric nanostructures. After chemical removal of the remaining gold clusters visible in Fig. 18(b), the hole-rim structure in the substrate becomes even more evident (Fig. 18(c)). It was found that the radius of curvature at the tips of the ablation holes can be as small as 5 nm, which was also the tip radius of the original gold structure. Since the substrate will be ablated under and near the plasmonic particle only where the local intensity is high enough, it was argued in ref. 83 that the resulting ablation pattern in the substrate thus represents a nonlinear “photograph” of the optical near field distribution of the nanoparticle under study.

The method works for the same kind of gold triangles not only on silicon, but also on smooth glass substrates, as demonstrated by Jamali et al. 88. Figures 18 and 19 were a clear proof of the field enhancement at sharp tips of plasmonic structures. Moreover, they demonstrated that imaging optical near-field intensities by means of this method is possible not only for relatively broad, smeared-out distributions like simple dipolar patterns as in Fig. 10, but also for more complex near fields, and with a resolution of better than 1/50 of the incident light wavelength λ = 800 nm. Compared to the aSNOM mentioned earlier and related techniques it has the advantage that no probe tip is required which might disturb the near-field distribution. It adds to other powerful methods for imaging optical near fields which do not rely on a probe tip, e.g. two-photon polymerization 89-91, photochemical imaging 92, phase change in certain chalcogenide films 93,94, parabolic-mirror-based confocal microscopy 95, spatially resolved third harmonic emission 96, and photoelectron microscopy (PEEM) 97,98. Advantages of the nanoablation technique are the high resolution, relative simplicity, and that it can be applied under ambient conditions. In addition to ablation of silicon and glass substrates, also polymer coatings have since been used for electromagnetic-field-enhancement mapping around nanostructures 99.

On closer inspection, the observed ablation pattern shown in Fig. 18 caused a puzzle: although it was expected that the near-field pattern of a metallic triangle, when illuminated with polarized light, is anisotropic and displays strong field enhancement at the triangle tips, the orientation of the field enhancement was surprising. One could have expected that field enhancement occurs mainly at the tips parallel to the polarization of the electric field, like in a dipole antenna. However, Fig. 18 shows that the intensity was largest for the tips aligned perpendicular to the electric field, and the tip pointing in the direction of the polarization did not bear a visible sign of field enhancement. (Another observation of “unexpected” polarization has more recently been reported by Metzger et al. 100 for the second-harmonic near field of inversion-symmetric gold dipole nanoantennas. The authors report strong experimental evidence that the second-harmonic dipole field was predominantly oriented perpendicular to the dipole’s long axis, although the excitation laser was polarized parallel to the dipoles.)

A hint for the origin of this apparent contradiction in the case of nanotriangles came from studying triangles of different size. For the smallest ones, with a side length of 160 nm, the field enhancement was highest for the tip in the field direction, in agreement with naïve expectation,
and also with calculations\textsuperscript{83}. For an intermediate size with 240 nm side length the field enhancement reached its maximum not at the tip, but rather in the middle of the edge perpendicular to the plane of polarization. These examples showed that plasmon resonances in metallic nanostructures can be quite complex because of the excitation of higher multipole modes, depending on size (and, as it turned out later, also on several other parameters, like the curvature of the triangle edges). A clue in that direction, however with much lower resolution, also came from far-field measurements on colloidal-mask-generated triangles using confocal scanning microscopy\textsuperscript{101}. It was clear, therefore, that for a better understanding of the described near-field patterns a more thorough investigation, in particular also by means of simulations, was required.

In the course of time, various simulation techniques have been applied to model the near-field distribution of nanostructures, the most frequently used ones being the Discrete Dipole Approximation (DDA) and Finite Difference Time Domain (FDTD) simulations\textsuperscript{102}. An example for a DDA simulation which models the plasmon modes of single flat triangular structures is shown in Fig. 20 for two sizes, 480 and 240 nm side length, and two polarization directions of the incident beam with respect to the orientation of the triangle. For polarization along a triangle baseline one observes in the upper row two identical peaks of the field enhancement in the two corners along the polarization. For incident light polarized perpendicular to that direction, the intensity in one of the corners is about 6 times higher than in the other two corners. As one can see in the lower row of the figure, this behavior qualitatively does not change for the two sizes studied.

A comparison of Fig. 20 with experimental patterns like in Fig. 18 revealed that, while the calculated near-field distributions for the small triangles are in agreement, the discrepancy for the larger ones persisted. It was then suggested that the disagreement might be caused by the periodic array of the particles in the experiment, which might give rise to interference effects, whereas the calculations had been performed for individual triangles. However, a subsequent experiment with isolated triangles did not yield a significantly different

\begin{figure}[h]
\centering
\includegraphics[width=\textwidth]{Fig_20}
\caption{Field intensity distribution, as calculated by means of DDA, at the interface between a Si wafer and a 480 nm side length triangle (upper row) and a 240 nm side length triangle (lower row) of 30 nm height ($\lambda = 800$ nm, left side: polarization along $y$; right side: polarization along $z$). Figure reproduced with permission from ref.\textsuperscript{103}, Springer Nature.}
\end{figure}
near-field distribution, ruling out this explanation\textsuperscript{103}. Another difference between the conditions in the simulation and the experiment was the actual shape of the triangles: whereas the calculations had been performed assuming triangles with straight edges, the experimental structures had slightly curved edges due to the preparation using nanospheres. Taking this feature into account eventually solved the riddle: Figure 21 presents simulation results (this time with FDTD simulation software by Lumerical Inc., which allows for a highly detailed 3-dimensional modeling of the plasmonic structure and its surroundings) for the near-field enhancement of small (85 nm) and large (540 nm) triangles with curved edges, and – to be even closer to the experiment – for hexagonal arrays of these structures\textsuperscript{104}. Figure 22 shows for comparison the experimental nano-ablation patterns for the same sizes. The agreement in the patterns is now quite remarkable. This demonstrates that an unimportant detail at first sight can be essential for the proper simulation of plasmonic nanostructures. The FDTD calculation correctly assigns the observed patterns to multipole excitations of the larger triangles. This explains the strong difference to the smaller triangles, where the wavelength is close to the primary (dipolar) resonance. As an additional result, the inset in Fig. 21 (right) for the simulation of an isolated triangle shows that for this particle size there is no essential difference to the periodic array, also in line with the experimental finding\textsuperscript{103}.

In order to check the relevance of the detailed shape of a plasmonic structure for its near field even further, a direct comparison for the two triangle shapes discussed above was carried out by Kolloch\textsuperscript{105,106}. In this case all the structures were prepared by electron beam lithography, with identical thickness and tip distances in each triangle, just the edges were straight in one case and curved in the other. The ablation patterns (Fig. 23) confirm the previous results and are in convincing agreement with the corresponding FDTD simulations (Fig. 24). Moreover, the straight-edged triangles exhibit closely the patterns predicted several years earlier by the DDA.
calculations. For DDA simulations, the importance of such highly detailed models has also been shown by Perassi.

The same method of nanolithographic mapping of near-field distributions via ablation has recently been applied by Nagy et al. in an investigation of near-field-induced femtosecond breakdown of gold triangles of about half the structure size shown in Fig. 23. Results for the near-field distribution of somewhat bigger triangular gold structures than in Fig. 23 have been obtained by Scheffler et al. using multiphoton photoemission electron microscopy (nP-PEEM), and good agreement with finite element simulations was also found in this case.

Whereas for the spatial distribution of the near field enhancement quite satisfactory agreement has been achieved between experiment and simulations, there is still some gap regarding the absolute values of the enhancement. Typically, the experimental enhancement factors are distinctly below the calculated ones, especially if details of the structure like roughness, tip radius and inclination of the edges are not properly taken into account. So far, there exist only few quantitative investigations; for some triangular structures, the experimentally determined enhancement (based on a method of evaluating the ablation thresholds with and without particles) was by a factor of 2 to 5 below the simulation results.

Like for the dielectric nano-spheres discussed in Section Optical near fields of dielectric nanostructures, also the optical near fields of plasmonic particles can be used for the purpose of nanostructuring surfaces, with a large variety of patterns that can be generated. Important parameters are the polarization, fluence and angle of incidence of the laser light, the size of the structures and their thickness, the refractive index of the substrate, etc. Two examples are shown in Figs. 25 and 26 for the case of gold triangles, which were used for structuring a glass surface applying the techniques described above.

With the profound understanding in simulating optical near fields that has been achieved, based on the mutual feedback between simulations and experiment, reliable predictions are now feasible how to tailor plasmonic nanostructures in order to obtain a desired pattern by means of laser nanoablation.

The near-field enhancement in metallic nanostructures due to plasmonic excitations can be used not only to pattern the surrounding material, but also to modify the plasmonic structures themselves. For this purpose, picosecond pulses are most suitable: they last long enough to allow local melting of the nanostructure in the regions of high near field, but are still so short that the thermal diffusion and hence melting does not extend over the whole structure, as is the case for ns pulses. Figure 27 shows the result of irradiating an array of Au triangles with a single ps pulse; only two tips of each triangle are modified under the conditions of this experiment. A comparison of the six different triangles in the inset reveals that even the details of the molten tips are nearly identical for triangles with the same orientation.

Other plasmonic nanostructures
The focus of this historical review is on the optical near fields of triangular gold structures and their nano-ablation patterns. There are, however, also many investigations of patterns generated by other plasmonic structures like metallic spheres and rods, which started...
somewhat later. Overviews over plasmonic near fields, their imaging and applications for nanoprocessing have been given in the last decade in a number of review articles, see, e.g.\textsuperscript{114−119}.

An early investigation of the optical near fields and nano-hole fabrication by spherical gold particles with sizes of 40, 80 and 200 nm was presented in 2006 by Nedyalkov et al.\textsuperscript{84,120}. These authors pointed out that the observed nano-hole profiles in the fluence region below the ablation threshold of bulk Si resembled the laser intensity distribution on the substrate surface. When linearly polarized laser radiation was used, the holes were found to exhibit an elongated shape in the direction of polarization, similar to the case of small dielectric spheres, but with a much higher enhancement; for 200 nm spheres, enhancement factors of 26 and 7.5 were found in simulation and experiment, respectively. The hole diameters were between several ten and hundred nm, the hole depths ranged from a few to several ten nm.

A similar study was carried out about a year later by
Eversole et al.\cite{Eversole2011} who investigated also the difference between perpendicular and inclined incidence of s- and p-polarized light. They found that the measured field-enhancement values agreed well with the calculated ones, and in some case even a slight increase above the theoretical value was observed.

In the same year, Nedyalkov et al. studied the nano-ablation by gold spheres on a different substrate, namely a platinum film\cite{Nedyalkov2012}. Since the spheres partly formed 2-dimensional aggregates, similar to dielectric colloid spheres, these authors obtained also results for such arrays and checked the influence of the interparticle distance on the field enhancement. It turned out that for these metallic spheres – in contrast to dielectric ones – edge particles display the strongest field enhancement. Again, the experimental results confirmed the theoretical findings and demonstrated that the produced near fields can lead to a permanent substrate modification. Somewhat later, Hashimoto et al.\cite{Hashimoto2013} observed the formation of craters of less than 10 nm diameter in borosilicate glass substrates upon irradiating 40 nm gold nanoparticles with a nanosecond pulsed laser beam. Imamova et al.\cite{Imamova2018} reported the preparation of metallic nanoparticle arrays by laser annealing and dewetting of thin Au and Ag films on SiO$_2$ substrates and obtained also images of the near fields of the such-produced particles by the nano-ablation method.

In addition to metallic spheres, also metal nanorods have been used for optical near field and laser ablation studies. Using Au nanorods on a Si substrate, Harrison et al. investigated the role of near-field enhancement for...
such structures in plasmonic laser nano-ablation\textsuperscript{123,124}. Near the ablation threshold, features as small as $22 \times 66$ nm, given by the size of the gold particles, were found as “photo-imprints” (Fig. 29).

From their results Harrison et al. concluded that the rod-shaped ablation structures matched the enhancement patterns of the Poynting vector magnitude rather than the electric field $|E|^2$ enhancement pattern, as used in most previous work. This result was disputed by the group of Meunier\textsuperscript{125} who showed that in their experiment the data matched the $|E|^2$ pattern. The latter result was also found by Kolloch to hold for his ablation patterns of triangular gold structures\textsuperscript{105}, as shown in Fig. 30.

Meunier’s group also addressed the question what eventually limits the size of the ablation features in Si substrates\textsuperscript{126}. Again, gold nanorods were used as

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**Fig. 28** | AFM images of nanocraters ablated by 150 nm gold nanoparticles on silicon (100) and corresponding cross section as found along the white dotted line. The laser pulse width was 220 fs, the wavelength 780 nm and the fluence 128 mJ/cm$^2$; the light was s-polarized at 45° incident angle. The scale bar is 200 nm. Figure reproduced with permission from ref.\textsuperscript{110}, Springer Nature.

**Fig. 29** | Nanoscale ablation site and depth profile: SEM images of the nanorods before and after laser irradiation at a local effective fluence of (a) 54 mJ/cm$^2$, right at the ablation threshold, and (b) 218 mJ/cm$^2$. The scale bars correspond to 75 nm and the yellow arrows indicate the incident polarization. (c) The depth profile of the ablation site shown in (b), along the long axis shown with the dotted line as obtained using AFM. Note the different scales for the horizontal and vertical axes in (c). Figure with permission from ref.\textsuperscript{129}, The Optical Society.

**Fig. 30** | Simulations of the near-field enhancement $|E|^2$ (a) and of the norm of the Poynting vector distribution $|P|$ (c) for a round-edged triangle as prepared by e-beam lithography. The middle (b) shows the experimental ablation pattern. A comparison reveals that the experimental pattern agrees much better with (a) than with (c). Figure reproduced from ref.\textsuperscript{105}.
plasmonic particles. The observed hole shape seemed inconsistent with the calculated field distribution, but using a carrier diffusion-based model both the shape and the depth of the nanoholes could be explained. According to this model, charge carriers created as electron-hole pairs in the nanostructure’s enhanced near field diffuse before they transfer their energy to the Si lattice, producing ablation. As the authors point out, the strong localization of the energy absorption, which can be distinctly smaller than the carriers’ diffusion length, is the key difference between nano-ablation and conventional laser ablation$^{127,128}$ of silicon. A similar argument has been put forth by Kolloch$^{105,106}$ based on the size of near-field ablated nanoholes at the apex of an optical bow-tie antenna. Carrier diffusion will thus limit the achievable minimum ablation feature size in silicon to the so far observed scale of about 10 nm$^{83,84}$ even if plasmonic structures with more tightly confined near fields could be prepared. With other materials, however, where this broadening process is absent, even smaller features might be accessible.

An overview over the nanostructures generated by plasmonic near fields, as discussed in this chapter, is given in Table 2. As in Table 1, only the most important

<table>
<thead>
<tr>
<th>Year</th>
<th>Structured material</th>
<th>Plasmonic structure: shape and size (nm)</th>
<th>Plasmonic material</th>
<th>λ (nm)</th>
<th>Laser pulse length</th>
<th>Created nanostructures</th>
<th>Special feature</th>
<th>Reference</th>
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</thead>
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<tr>
<td>2004</td>
<td>Si</td>
<td>triangles side length 160,240,450</td>
<td>Au</td>
<td>800</td>
<td>150 fs</td>
<td>holes, min. diam. 10 nm</td>
<td>particle array</td>
<td>ref.35</td>
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<td>Au</td>
<td>820</td>
<td>100 fs</td>
<td>holes, min. diam. 40 nm holes</td>
<td>particle array</td>
<td>ref.36</td>
</tr>
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<td>Pt</td>
<td>spheres, dia. 200</td>
<td>Au</td>
<td>800</td>
<td>100 fs</td>
<td>holes</td>
<td>particle array</td>
<td>ref.38</td>
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<td>Au</td>
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<td>220 fs</td>
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<td>vertical and inclined incidence</td>
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<td>800</td>
<td>150 fs</td>
<td>holes</td>
<td>particle array</td>
<td>ref.102</td>
</tr>
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<td>channels, width 96 nm</td>
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<td>Au</td>
<td>780</td>
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<td>Au</td>
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<td>35 fs</td>
<td>particle array</td>
<td>ref.122</td>
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<td>Au</td>
<td>800</td>
<td>150 fs</td>
<td>particle array</td>
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<td>Au</td>
<td>800</td>
<td>150 fs</td>
<td>particle array</td>
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<tr>
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<td>Au</td>
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<td>35 fs</td>
<td>holes, dia. 100 nm</td>
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<td>790</td>
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<tr>
<td>2020</td>
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<td>Au</td>
<td>803</td>
<td>40 fs</td>
<td>near field image craters</td>
<td>particle array, multiple laser pulses</td>
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parameters are mentioned here, for details the reader is referred to the original papers.

Conclusions

It was the goal of this historical review to give an impression of the early investigations of optical near-field structuring, dating back about 20 years, out of which the more recent applications developed. This history is an example that often new methods emerge out of studies with a quite different perspective. The starting point of near-field nanopatterning was laser cleaning in the 1990s. There the aim was just the opposite, namely to remove contaminating nanoparticles from delicate surfaces without any modification of the substrate. Once it was clear, however, that dry laser cleaning - in spite of its at-first-sight gentle and contactless removal concept - gave rise to local ablation in the substrate, this new possibility of nanostructuring was quickly adopted and studied by a number of groups worldwide. In the beginning, the focus was on structuring surfaces by means of the near field of transparent nanospheres, which offer the additional advantage that they easily self-organize in large regular arrays and thus enable one to pattern surfaces with thousands or millions of nanoholes in a one-step process with just one laser pulse on many substrates of choice, including metals, semiconductors and dielectrics. With the methods being refined in the course of time, structures more complex than just periodically arranged round holes could be generated with the near fields of these nanospheres, and in addition also chemical etching and other nanoscale surface modifications were achieved, which are interesting for chemical, biological and medical purposes.

Metallic (that is plasmonic) structures can enhance electromagnetic fields even more and to even smaller scales than dielectric ones. This has been demonstrated not only for nanostructuring with spheres, but also with less symmetric objects such as triangles, rods, etc. Since in the field of plasmonic applications the detailed distribution of the optical near fields is of paramount importance, many efforts have been directed towards imaging these near fields. Nanoablation has in this context proven as a convenient method with high resolution and without the often disturbing influence of a probe tip, as it is necessary for some of the other imaging techniques. The in-depth comparison of the experimental ablation patterns with simulations have revealed excellent agreement in the spatial distribution of the near fields, provided all the essential details of the plasmonic object are taken into account in the simulations. It has also been shown, however, that the calculated enhancement factors are typically somewhat larger than the experimental ones, yet of the same magnitude. From such knowledge one can draw conclusions how trustworthy simulations of more applied structures like optical antennas or plasmonic tweezers ref.13,14 can be.

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Competing interests

The authors declare no competing financial interests.